

ENGIS[®] MICROTECH WAFER MOUNTING SYSTEMS

ADVANCED MATERIALS PRODUCTS

- **FAST, EASY AND SAFE FOR OPERATOR'S USE**
- **ALLOWS FOR REPEATABLE WAX BOND THICKNESS**
- **IMPROVED PART FLATNESS/THICKNESS**
- **OPERATOR SKILL/INTERVENTION NOT REQUIRED**
- **MODULAR DESIGN**



- UNITS FOR 6" - 12" PLATE DIAMETER CAPACITY
- FAST MOUNTING BLOCK COOLING
- ADJUSTABLE PNEUMATIC PRESSURE
- ATTRACTIVE ERGONOMICS
- MULTI UNITS CAN BE RUN IN-LINE
- REPEATABLE & EVEN WAX THICKNESS
- AVAILABLE IN 2, 3 OR 4 STATION VERSIONS
- MODULAR, NON-CORROSIVE CONSTRUCTION
- NORMAL TAP WATER CAN BE USED
- NON-CONTACT HEAT DISSIPATION SYSTEM MAINTAINS COOLING WATER CLEANLINESS FOR DIRECT DRAINAGE
- FAST MOUNT & DE-MOUNT TIMES



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